Q-PILON®

Block Co-Polyimide
The Ultra-high heat resistant resin wit
unlimited notential

<u>Polyimide modified Epoxy Bonding sheet</u> <u>Introduction of Q-BF-9100G</u>

Application: Insulation Layer for Multi layer FPC, Flex rigid, etc

1-1)Outline

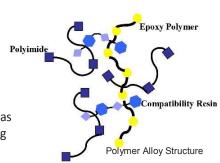
1.Outline and Feature

1-2)Feature

Multilayer FPC and the interlayer insulation film for flex rigid. The main ingredients are epoxy resin and polyimide resin. It has been polymer-alloy-ized by using our original denaturation technology

Excellent in heat resistance and flexibility of polyimide, and compatible with excellent in processability of epoxy.

Moreover, It's not only correspond to multilayering as well as vacuum press fabrication, but also at the vacuum laminating machine, and it also contribute to reduction of process expense

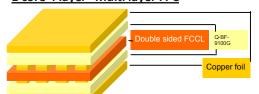


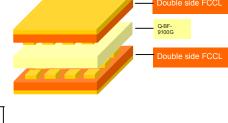
2.Application

2-1)Multi layer FPC

2-2)Flex rigid

1 core 4 layer Multi layer FPC





2 core 4 layer Multi layer FPC

Double sided FCCL Q-BF-9100G

FR-4 Double sided board

This product, joint with FCCL and CCL, also serve a function of cover-lay. Thinner and process shortening are also possible.

3. Physical properties

Item	Unit	Feature	Remark
Glass transition point	°C	142	TMA
Heat expansion	ppm/°C	70	α1、TMA
coefficient		250	α2、TMA
Elastic-modulus	GPa	1.8	JPCA-BU01-2007
Tensile strengh	MPa	87	JPCA-BU01-2007
Elongation	%	10.8	JPCA-BU01-2007
Peel strengh	kN/m	1.0	18um VLPCopper foil
Thickness	um	15,20,25,30,40,50	Micrometer, Postforming

4. Usage instruction

Vacuum press condition

Forming condition: 130°C×30min / 0.5MPa

+190°C×75min / 2MPa

Vacuum laminate condition

110°C×30sec./ vacuum

+ 110°C×30sec./ 0.8~1.0MPa

Cure condition: 130°C×30min+190°C×75min

4.Contact

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